

SUPPLEMENTAL INFORMATION

TOEFL Score (for international students)
 NOTE: PLEASE HAVE OFFICIAL SCORE SENT TO ASIA PACIFIC COLLEGE.
 TOEFL Score _____ Date taken _____

Professional Background (attach additional sheets as needed)

Company Name	Position	Date		Location	Brief job description/Accomplishments
		From	To		

Academic / Community Activities (attach additional sheets as needed)

Name of Organization/Activity	School/Location	Date		Position(s) held	Accomplishments
		From	To		

APPLICATION REQUIREMENTS

- Completed and signed application form
- Application fee of \$50.00
- Official transcripts in English or with English translation provided (one from each college or university attended, mailed directly to Asia Pacific College from issuing institution OR included with this application in a sealed envelope from issuing institution)
- 2 letters of recommendation addressing academic or professional potential
- Statement of intent indicating why you want to participate in the MIL program and what you expect to gain from such participation. Summarize what you see as your professional future at this time. Also, describe any community service work that you have done on a voluntary basis. Minimum 250 words.
- Writing sample describing a leadership problem that concerns you. Speculate briefly on its causes and summarize what you think would be the best way of dealing with it. (Please limit the statement to five typed, double-spaced pages.)

ADDITIONAL REQUIREMENTS FOR INTERNATIONAL APPLICANTS

- Official TOEFL Score

I hereby certify that the information given in this application is complete and correct to the best of my knowledge. I understand that providing incomplete, incorrect, or false information may result in the termination of my application, revocation of all offers of admission and financial assistance, and/or termination of enrollment. I understand and agree that all submitted application materials are property of Asia Pacific College and will not be returned and that the application fee is non-refundable.

Signature of Applicant _____ Date _____